JetSys-5330 Rugged AI Platform
NVIDIA-BASED SMALL FORM FACTOR (SFF)

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DESCRIPTION

Elma's JetSys-5330 is a small form factor (SFF), rugged embedded computing system based on the NVIDIA® Jetson AGX Orin™ system-on-module (SoM). Housed in a rugged compact enclosure, the JetSys-5330 can deliver up to 275 TOPS of AI performance with the ability to tune the power consumption to match deployment requirements. The JetSys-5330 also offers numerous expansion sites, allowing it to be customized for I/O and storage needs.

The Jetson AGX Orin™ is a powerful AI inference engine system-on-module (SoM), featuring an NVIDIA® Ampere architecture GPU, an array of Arm® Cortex®A78AE CPUs, deep learning and vision accelerators, a video encoder/decoder, high-speed I/O, impressive 204 GB/s of memory bandwidth and 32GB or 64GB of DRAM, enabling these modules to feed multiple concurrent AI application pipelines.

This rugged system also provides a number of I/O options including HD-SDI, Gigabit Ethernet (with Power-over-Ethernet), or GMSL1/2 cameras, and 4/5G LTE, along with built-in USB3.0, CAN Bus, and other industry standard interfaces. The JetSys-5330 is IP67 rated for ingress protection and is qualified to MIL-STD-810G for operation in harsh environments.

The JetSys-5330 SFF embedded system is ideal for defense applications that require very high levels of computation, such as video and image processing, signal processing and deep learning in next generation autonomous vehicles, surveillance, targeting and electronic warfare (EW) systems.

Features

- Jetson AGX ORIN™ SoM (32GB or 64GB variant available)
- Expandable through two M.2 and three mPCI sites (one doubles as mSATA)
- 6-channel GMSL1/GMSL2 camera input
- HD-SDI and Gigabit Ethernet cameras supported
- Support for two removable solid-state drives
- Wireless connectivity via WiFi or 4G/5G LTE
- Door-accessible drive bay with support for up to two removable 2.5" solid state drives
- Fan kit available, if needed
- Rugged design; qualified to military standards, IP67 (MIL-STD-810G, MIL-HDBK-704F, MIL-STD-1275D, and others)

Benefits

- Powerful AI processing in a rugged, edge computing package
- Easily configurable and expandable to meet mission requirements
- Provides mission-critical rugged SFF autonomy with server-class AI processing in remote locations with challenging connectivity
- Offers real-time responsiveness, minimal latency, and low-power consumption
- Redefines the possibilities for extending advanced AI from the cloud to the edge
- Provides 275 TOPS and more than 5 TFLOP/s of AI processing performance

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RELATED PRODUCTS

ComSys Family

› Modular computing platforms with GbE, miniPCIe expansion
› High performance, modular SFF computers for edge processing

ComSys 5300 Family

NetSys Family

› Compact mobile, IP router
› Cisco router/Ethernet switch combination
› Railway compliant mobile router (ESR-5915)

cisco Technology

NetSys 5300 Family

APPLICATIONS

- Defense 360-degree situational awareness, automatic target recognition/tracking, etc
- Robotics in rugged environments
- Rugged autonomous vehicle applications: mining, agriculture, construction, etc
- Intelligent video analytics in remote/challenging environments

- Ideal for wireless multi access edge computing applications (MEC)
- Artificial intelligence (AI)
- Augmented or virtual reality (AR and VR)
- Computer vision
- Deep learning
- Robotic localization / mapping

The JetSys-5330 is a small form factor embedded system capable of running high performance intelligent video analytics (IVA), virtual reality (VR), augmented reality (AR) and artificial intelligence applications at the edge, as well as applications on unmanned vehicles and robots. Multiple camera interfaces make the JetSys-5330 an ideal platform for vision intelligence applications (e.g. object detection and tracking, semantic segmentation, scene understanding and video surveillance).

The JetSys-5330 using the NVIDIA® Jetson AGX Orin™ system-on-module (SoM), features a Deep Learning Accelerator (DLA) optimized for deep learning operations. The GPU is based on NVIDIA®'s Ampere architecture and is divided into two Graphic Processing Clusters (GPCs), up to 8 Texture Processing Clusters (TPCs), and up to 16 Streaming Multiprocessors (SMs). There are 128 CUDA cores per SM, providing up to 2048 NVIDIA® CUDA® cores and up to 64 (64GB) Tensor Cores depending on the AGX Orin™ model (32GB or 64GB). The GPU can run up to 1.3 GHz on the 64GB model. This provides up to 275 TOPS and 5.3 FP32 TFLOPs of CUDA computing power.

This processor is designed to do full hardware acceleration of convolutional neural network inferencing. The built-in video encoder / decoder, and Programmable Vision Accelerator give the AGX Orin™ unprecedented video and image processing power. This provides the power to run high performance deep learning-based inference engines to perform tasks such as object detection and image segmentation of multiple video image streams captured through GMSL 1/2, HD-SDI, Ethernet, or USB3.0 cameras interfaced using high- speed circular connectors. Developers can utilize NVIDIA®'s CUDA and deep learning SDK's to develop numerous applications in traffic control, human-computer interaction, augmented reality and visual surveillance based on object recognition and inference and enable rapid deployment of AI-based perception processing.

Optional enclosure for fan support

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SPECIFICATIONS

Processor
Jetson AGX Orin™, 32GB or 64GB

Interface	Video Capture
High-speed Networking: 10GBASE-T	GMSL – Up to six GMSL2/GMSL1 cameras in x2 or x4 CSI
Networking: 1000BASE-T	Up to three additional 1000BASE-T with PoE for Ethernet cameras
Audio • Mic In (mono) • Stereo Line In • Stereo Line Out • Stereo Headphone Out	HD-SDI Input – up to three channels
Display: Display Port 2.0, 1.4 with MST support	Other camera inputs available. Consult factory for details
USB: • USB 3.2 (3x) • USB Type C (2x) • USB2 (4x)	
CAN Bus (2x)	
Serial: • RS-422/485 (2x) • RS-232 (1x)	
GPIO (8x)	
Support for two removable solid-state drives	
Support for WiFi or 5G/5G LTE	
Fan kit available	

Expansion

Support for up to three mPCIe modules (one doubles as mSATA)	
Two M.2 sites • One B-key, with USB3, one-lane of PCIe and SIM card support • One M-key, with SATA and four-lanes of PCIe (NVMe)	

Environmental

Temperature:	-40°C to 55°C or 71°C operational, depending on the configuration -40°C to 85°C storage
Operating shock:	40 g; 11ms
Random vibration:	10Hz to 2000Hz
Humidity:	Up to 95% RH non-condensing
Ingress protection:	IP67

Power

Input	16.5VDC to 50VDC, 28VDC Nominal
Power consumption	52W to 130W depending on the configuration

Physical

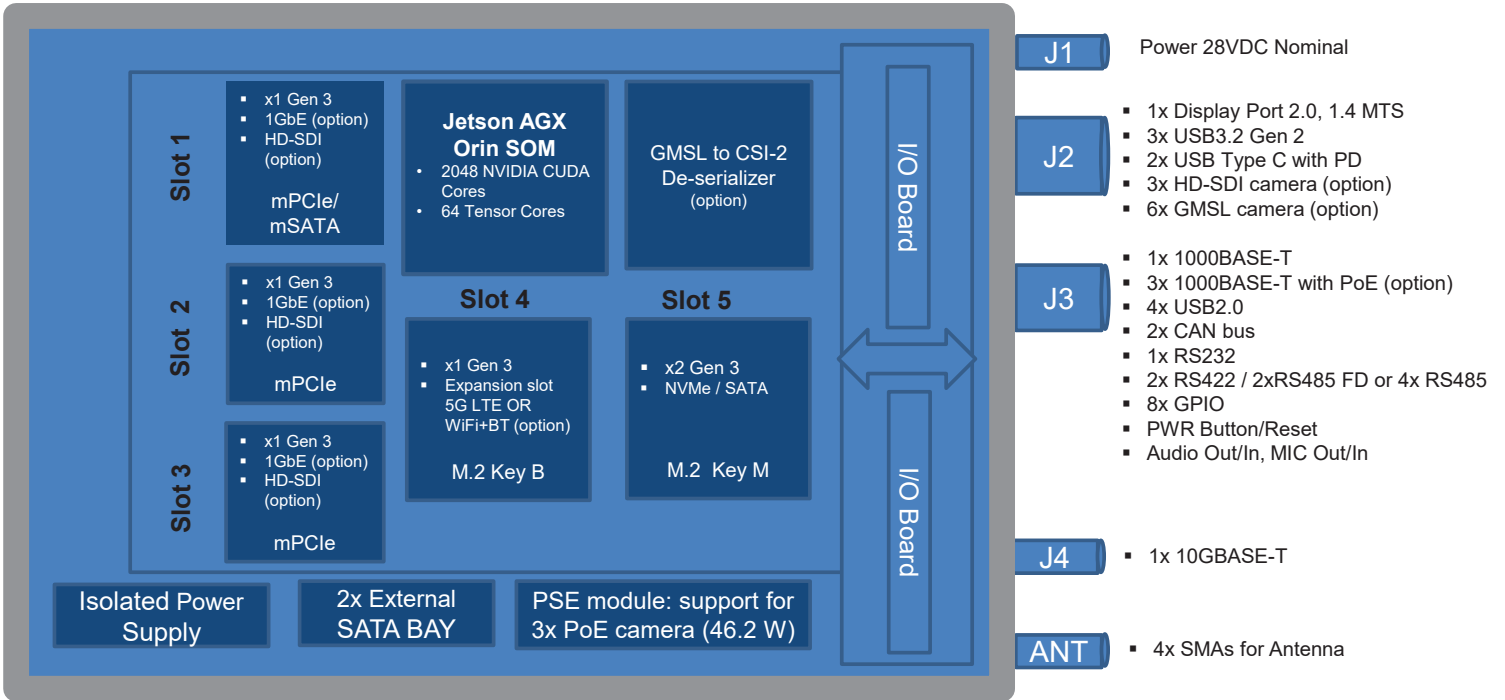|	
Height:	112.4mm (4.43"), 114mm (4.49") with the fan kit
Width:	343.5mm (13.52)
Depth	214.5mm (8.44"), 230mm (9.06") with the fan kit
Estimated weight	6.35kg to 7.26kg (14 to 16 lbs) depending on the configuration

Contact factory for additional environmental qualification details

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BLOCK DIAGRAM

J1		Power 28VDC Nominal
J2		- 1x Display Port 2.0, 1.4 MTS - 3x USB3.2 Gen 2 - 2x USB Type C with PD - 3x HD-SDI camera (option) - 6x GMSL camera (option)
J3		- 1x 1000BASE-T - 3x 1000BASE-T with PoE (option) - 4x USB2.0 - 2x CAN bus - 1x RS232 - 2x RS422 / 2xRS485 FD or 4x RS485 - 8x GPIO - PWR Button/Reset - Audio Out/In, MIC Out/In
J4		- 1x 10GBASE-T
ANT		- 4x SMAs for Antenna

Block diagram elements:

Slot 1: mPCIe/mSATA — x1 Gen 3, 1GbE (option), HD-SDI (option)

Jetson AGX Orin SOM — 2048 NVIDIA CUDA Cores, 64 Tensor Cores

GMSL to CSI-2 De-serializer (option)

Slot 2: mPCIe — x1 Gen 3, 1GbE (option), HD-SDI (option)

Slot 4: M.2 Key B — x1 Gen 3, Expansion slot 5G LTE OR WiFi+BT (option)

Slot 5: M.2 Key M — x2 Gen 3, NVMe / SATA

Slot 3: mPCIe — x1 Gen 3, 1GbE (option), HD-SDI (option)

Isolated Power Supply

2x External SATA BAY

PSE module: support for 3x PoE camera (46.2 W)

I/O Board

ORDER INFORMATION

JetSys-5320 Description

AGX Orin™ 64GB Six-channel GMSL2/GMSL1 Three HD-SDI interfaces 1TB Internal SSD 5G LTE	JetSys-5330-A1T.2S.L.B.PV.PV.PV.BS.ML.1
AGX Orin™ 64GB Six-channel GMSL2/GMSL1 Three 1000BASE-T with PoE 1TB Internal SSD 5G LTE	JetSys-5330- A1T.2S.L.BP.PN.PN.PN.BS.ML.1 Support for removable SSD options or customization of Front I/O and interfaces is available. Contact Factory
I/O Cable Kit (s)	CAE058081 Lab Cable Kit - consisting of: • CAE058026 J1 (Power) • CAE057695 J2 (High-Speed I/O) • CAE057696 J3 (Mid- to Low-Speed I/O) • CAE057697 J4 (10GBASE-T)

Please contact our sales team for more details.

United States: +1 510 656 3400
France: +33 388 56 72 50

Germany: +49 7231 97 34 0
Israel: +972 3 930 50 25

Singapore: +65 6479 8552
Switzerland: +41 44 933 41 11

United Kingdom: +44 1234 838 822